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9FG1903AK-1LFT

Category:

Generic Part:

Market Group:

Description:

9FG1903-1

PC CLOCK

PCIE BUGFFER

**Time is
money**

Parameters

Package	VFQFPN 72 (NLG72)
Speed	NA
Temperature	C
Voltage	3.3 V
Status	Active
Sample	No
Minimum Order Quantity	2500
Factory Order Increment	2500

Package

Description	VFQFP-N 10.0 X 10.0 X 0.9 MM - NO LEAD
Class	PLASTIC
Moisture Sensitivity Level (MSL)	3
Category	Green
Moisture Exposure Floor Life	168 hrs. @ <30°C/60%RH
Peak Reflow Temperature	260°C
Rebake Conditions	48 hrs.@125°C
Length	10.0
Mark	K
Width	10.0
Pitch	0.5
Thickness	1.0
Status	Active

Distributor Inventory

No Pricing information is available from our Distributors at this time.

Documents

Type	Title	Size	Revision Date
Misc	PC Clocks Contact Info	61 KB	05/29/2007
Product Change Notice	PCN# : A0701-02 Punch Singulation as Alternate Assembly Process for 10mm x 10mm VFQFP-N-72	514 KB	01/30/2007
	PCN# : A0701-02R1 Punch Singulation as Alternate Assembly Process for 10mm x 10mm VFQFP-N-72 and transfer Test facility from IDT Singapore to IDT Penang	453 KB	04/24/2007

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